TOSHIBA PHOTOINTERRUPTER INFRARED LED + PHOTO IC

T L P 1 0 2 0

IMAGE SCANNER, HANDY COPY

PHOTOELECTRIC TYPE COUNTER

COPYING MACHINE, FACSIMILE, PRINTER

VARIOUS POSITION DETECTION

TLP1020 is a digital output photointerrutper combining GaAs infrared LED with high sensitive and high gain Si photo IC.

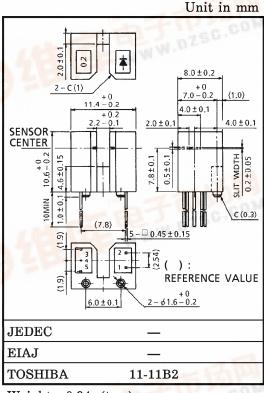
Because of the oblong detection slit, this photointerrutper is best suited to the upward-downward position detection.

Its output becomes low level when the light is shield. The same size TLP813 with phototransistor output is available.

- Printed wiring board direct mounting type (with a locating pin).
- Gap : 2.2mm
- High resolution :Slit width 0.2×2.0mm (the oblong slit)
- Digital output (open collector)
- Directly connectable to TTL, LSTTL and CMOS.
- Threshold input current: IFLH=10mA (max) at

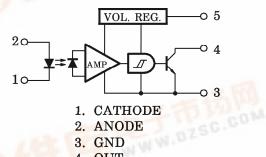
 $Ta = 25^{\circ}C$

- Supply voltage range : VCC=4.5~17V
- Built-in Schmitt circuit
- Fast response speed : $t_{pLH} = 3\mu s$, $t_{pHL} = 6\mu s$ (typ.)
- Detector side is of visible light cut type.



Weight: 0.94g (typ.)

PIN CONNECTION



- 1. CATHODE
- 2. ANODE
- GND
- 4. OUT
- 5. VCC

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Formula Semiconductor reliability individuals. GaAs is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the

products with other industrial waste or with domestic garbage.

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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
LED	Forward Current	${f I_F}$	50	mA	
	Forward Current Derating (Ta>25°C)	$\Delta I_{\mathbf{F}} / {^{\circ}\mathbf{C}}$	-0.33	mA/°C	
	Reverse Voltage	$v_{ m R}$	5	V	
	Supply Voltage	v_{CC}	17	V	
)R	Output Voltage	v_{O}	30	V	
CTC	Output Current	IO	50	mA	
TE(Power Dissipation	PO	250	mW	
DETECTOR	Power Dissipation Derating (Ta>25°C)	ΔP _O /°C	-3.33	mW/°C	
Operating Temperature Range		${ m T_{opr}}$	-25~85	°C	
Storage Temperature Range		$\mathrm{T_{stg}}$	-40~100	°C	
So	ldering Temperature (5s)	${ m T_{Sol}}$	260	°C	

RECOMMENDED OPERATING CONDITIONS

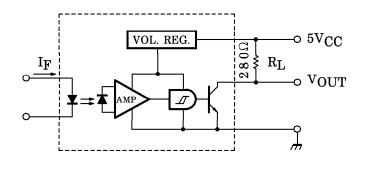
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED Forward Current	$I_{\mathbf{F}}$	23*		30	mA
Supply Voltage	v_{CC}	4.5	5	17	V
Output Voltage	v_{O}	1	5	24	V
Low Level Output Current	$I_{ m OL}$		_	16	mA

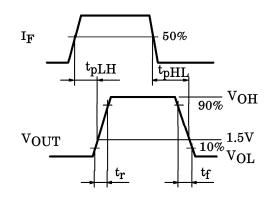
^{* 23}mA is a value when 30% LED deterioration is taken into consideration. Initial threshold input current shall be 15.5mA max

OPTO-ELECTRICAL CHARACTERISTICS (Unless otherwise specified, $Ta = -25 \sim 70^{\circ}C$, $V_{CC} = 4.5 \sim 5.5V$)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
LED	Forward Voltage	$ m v_{ m F}$	$I_F = 10$ mA, $Ta = 25$ °C	1.00	1.15	1.30	V	
	Reverse Current	${ m I}_{ m R}$	$V_R=5V$, $Ta=25$ °C	_	_	10	μ A	
	Reverse Current Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	$I_F = 25 \text{mA}, Ta = 25 ^{\circ}\text{C}$		940		nm	
DETECTOR	Supply Voltage	v_{CC}	1	4.5		17	V	
	Low Level Supply Current		$I_{\mathbf{F}} = 0$	_	_	5.0	mA	
			$I_F = 0$, $V_{CC} = 17V$			5.2		
	High Level Supply	ICCH	$I_{\mathbf{F}} = 25 \text{mA}$		_	3.0	mA	
	Current		$I_F=25mA,\ V_{CC}=17V$	_	_	3.2	mA	
	Low Level Output Voltage	$ m V_{OL}$	$I_{ m OL}$ =16mA, $I_{ m F}$ =0 Ta=25°C	_	0.07	0.3	V	
	Low Level Output Voltage		$I_{OL}=16mA$, $I_{F}=0$ $V_{CC}=17V$	_	_	0.4	V	
	High Level Output Current	ІОН	$I_F=25mA$, $V_O=30V$	_	_	15	μ A	
	Peak Sensitivity Wavelength	$\lambda_{\mathbf{P}}$	Ta=25°C	_	900	_	nm	
COUPLED	L→H Threshold Input	In T	Ta = 25°C			10	mA	
	Current	${ m I_{FLH}}$	$V_{CC} = 17V$	_	—	15.5		
	Hysteresis Ratio	$I_{\mathrm{FHL}}/I_{\mathrm{FLH}}$	Ta=25°C	_	0.67	_		
	Propagation (L→H)	$ m t_{pLH}$		_	3	_		
	Delay Time (H→L)	$ m t_{pHL}$	V_{CC} =5 V , I_{F} =25 m A	_	6	_	μ s	
	Rise Time	t_r	$R_L = 280\Omega$, $T_a = 25$ °C (Note)	_	0.1	_	μ s	
	Fall Time	t_f		_	0.05	_		

NOTE: SWITCHING TIME TEST CIRCUIT





PRECAUTION

Please be careful of the followings.

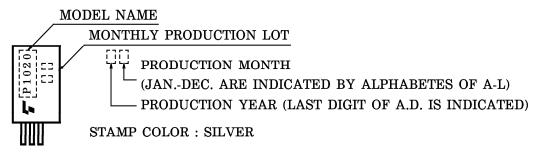
- 1. Soldering should be performed after lead forming.
- 2. If chemicals are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
- 3. The container is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with pertochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when chosing a packaging material by referencing the table below.

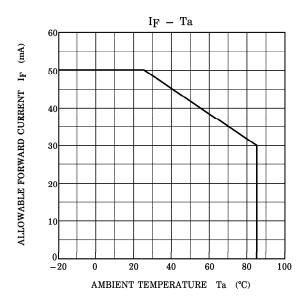
<Chemicals to avoid with polycarbonate>

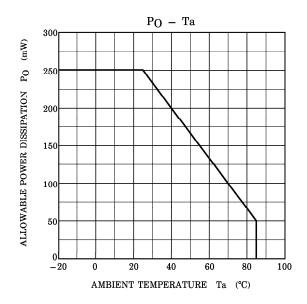
	PHENOMENON	CHEMICALS	
Α	Little deterioration but staining	• nitric acid (low concentration), hydrogen peroxide, chlorine	
В	Cracked, crazed, or swollen	 acetic acid (70% or more) gasoline methyl ethyl ketone, ehtyl acetate, butyl acetate ethyl methacrylate, ethyl ether, MEK acetone, m-amino alcohol, carbon tetrachloride carbon disulfide, trichloroethylene, cresol thinners, oil of turpentine triethanolamine, TCP, TBP 	
С	Melted { }: Used as solvent.	 concentrated sulfuric acid benzene styrene, acrylonitrile, vinyl acetate ethylenediamine, diethylenediamine [chloroform, methyl chloride, tetrachloromethane, dioxane 1, 2-dichloroethane 	
D	Decomposed	ammonia water other alkali	

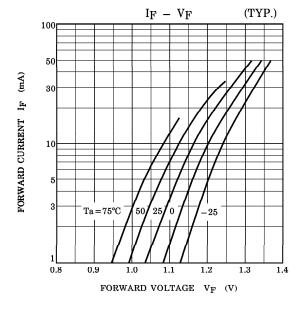
- 4. During $100\mu s$ after turning on V_{CC}, output voltage changes for stabilizing the inner circuit.
- 5. Supply the by-pass condenser up to $0.01\mu\mathrm{F}$ betweeen V_{CC} and GND near device to stabilize the power supply line.

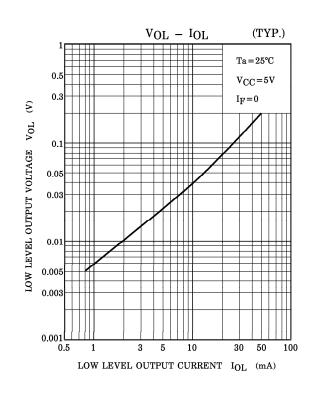
PRODUCT INDICATION

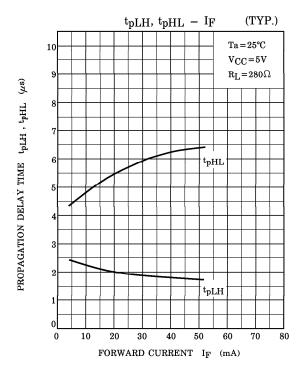


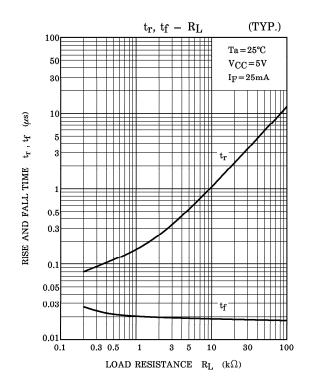


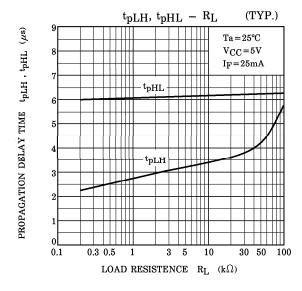


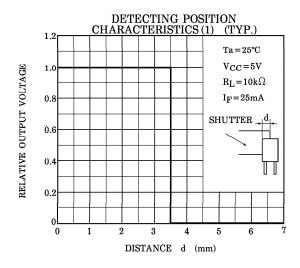


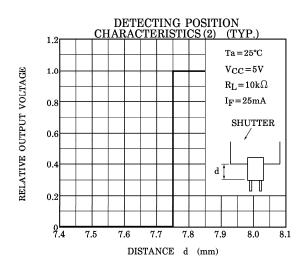










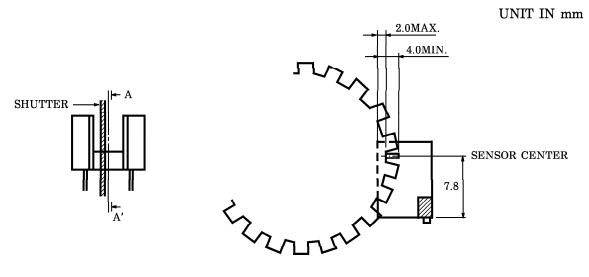


POSITIONING OF SHUTTER AND DEVICE

To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.

The shit pitch of the shutter must be set wider than the slit width of the device.

Determine the width taking the switching time into consideration.



A-A' CROSS SECTION